

HVD327C

Variable Capacitance Diode for VHF tuner

REJ03G0218-0100Z

Rev.1.00

Apr 16, 2004

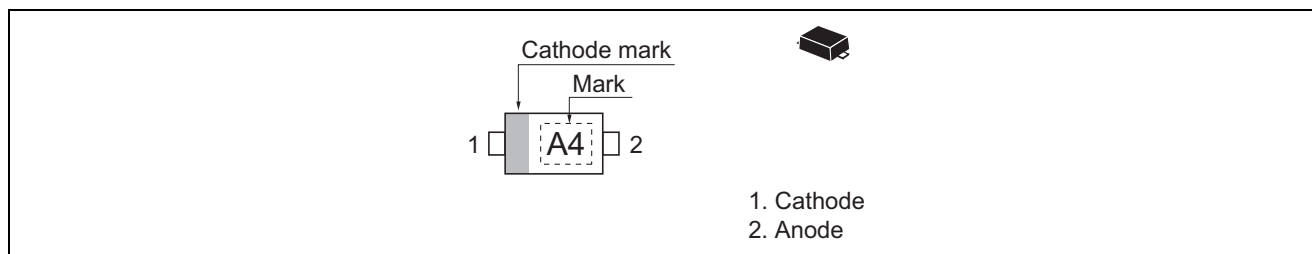
Features

- Low voltage type (tuning voltage 1 to 10V), it is suitable for ET without DC/DC converter.
- High capacitance ratio ($n = 11.0$ min).
- Low series resistance and good C-V linearity.
- Super small Flat Package (SFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVD327C	A4	SFP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V _R	15	V
Junction temperature	T _j	125	°C
Storage temperature	T _{stg}	–55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I _{R1}	—	—	10	nA	V _R = 10 V
	I _{R2}	—	—	100		V _R = 10 V, Ta = 60°C
Capacitance	C ₁	30.5	—	33.5	pF	V _R = 1 V, f = 1 MHz
	C ₁₀	2.6	—	2.9		V _R = 10 V, f = 1 MHz
Capacitance ratio	n	11.0	—	—	—	C ₁ /C ₁₀
Series resistance	r _s	—	—	0.8	Ω	V _R = 5 V, f = 470 MHz
Matching error	ΔC/C *1	—	—	2.0	%	V _R = 1 to 10 V, f = 1 MHz

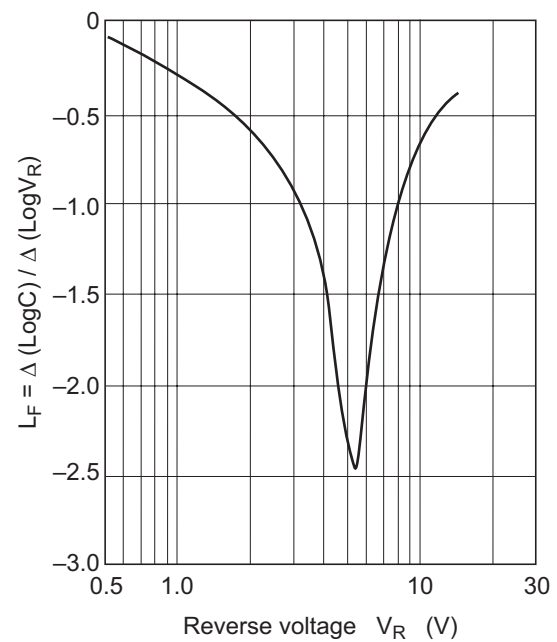
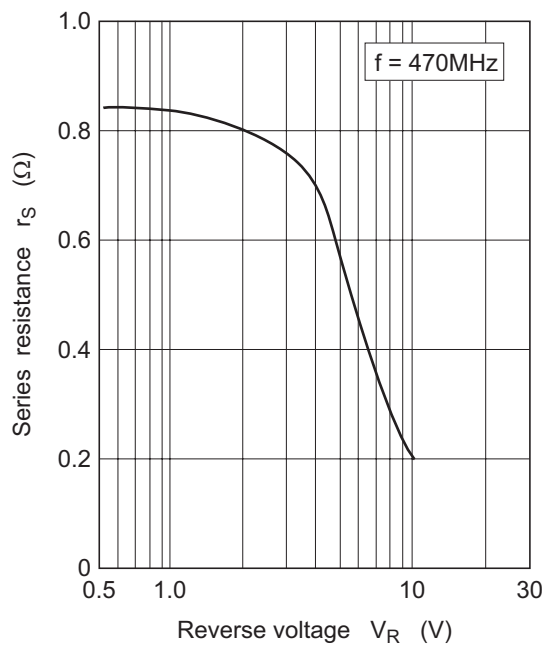
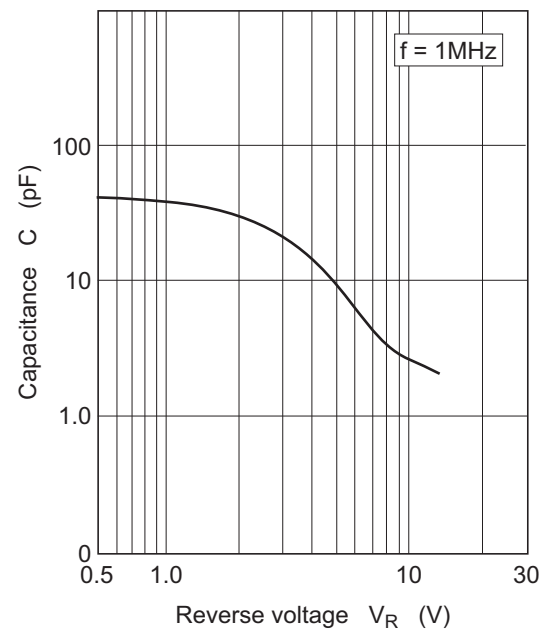
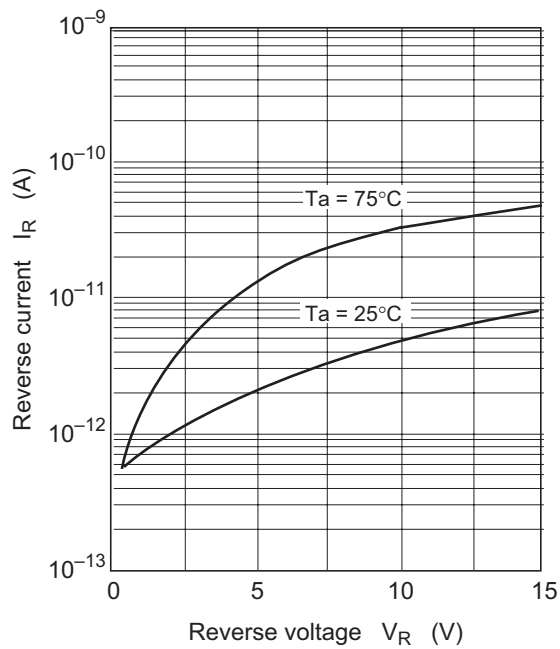
Note: 1. C.C system (Continuous Connected taping system) enable to make any 10 pcs of ΔC/C continuous in a reel, expect extention to another group.

Calculate Matching Error,

$$\Delta C/C = \frac{(C_{\max} - C_{\min})}{C_{\min}} \times 100 (\%)$$

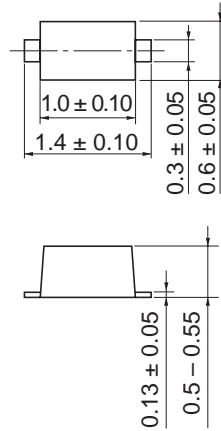
2. Please do not use the soldering iron due to avoid high stress to the SFP package.
3. The material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Main Characteristic



Package Dimensions

As of January, 2003
Unit: mm



Package Code	SFP
JEDEC	—
JEITA	—
Mass (reference value)	0.0010 g

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